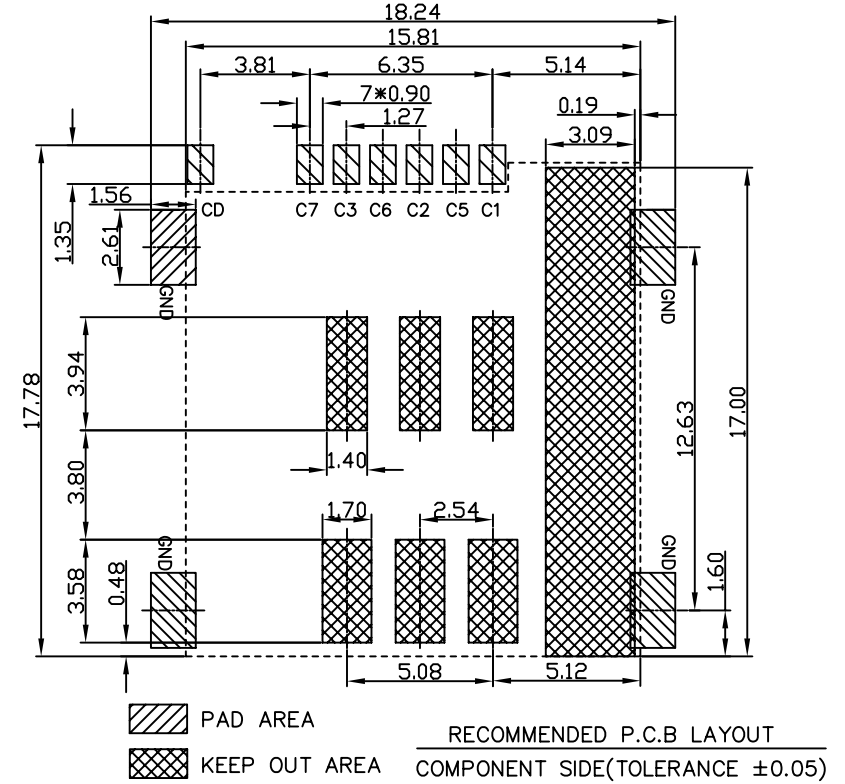
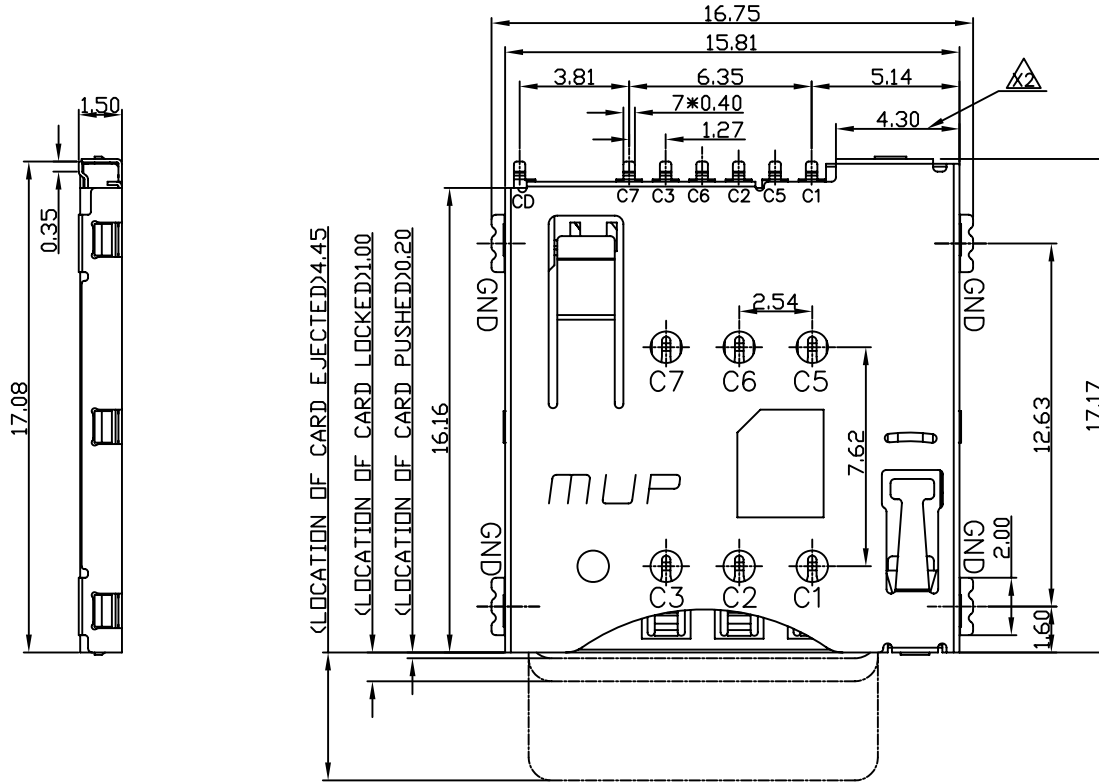


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2	设计变更		Henry		2016.6.25



TECHNICAL CHARACTERISTICS

1. General Characteristics

Dimensions: 15.75LX17.17WX1.50H mm
Weight: Approx 0.4±0.1g
Durability: 1500 cycles min.

2. Electrical Characteristics

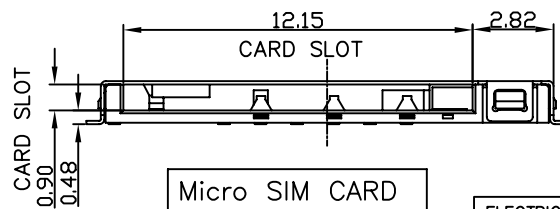
Contact resistance;
Date Contact: 150mΩ max
CD Switch: 500mΩ max
Insulation resistance: >1000MΩ/500V DC

3. Solderability

Vapor phase: 215°C, 30sec. Max
IR reflow: 250°C, 5sec. Max
Manual soldering: 370°C, 3sec. Max

4. Environmental Characteristics

Operating temperature: -40°C~+85°C
Operating humidity: 10%~+95%RH



Micro SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area: Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area: Gold plated
4	SHELL	1	Stainless Steel	SMT area: Gold plated
5	COIL SPRING	1	SWP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	

Unless otherwise specified, other tolerance are:

MUP MUP INDUSTRIAL CO.,LTD.

X ±0.35	X' ±5'	NAME: MicroSIM Card Connector	
X.X ±0.25	X.X' ±4'	MODEL NO: MUP-C792	
X.XX ±0.15	X.XX' ±3'	TYPE: Normally CLOSE H1.50 6PIN	
X.XXX ±0.10	X.XXX' ±2'		
PROJ.	UNIT mm	SCALE 1:1	DRAWN
CUSTOMER DRAWING			CHECKED
			APPROVAL
			DWG NO: DWG-MUP-C792-002
			SHEET 1/1
			REVISION X1